



# Product Change Notification

## 111808 - 00

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# Product Change Notification

**Change Notification #:** 111808 - 00  
**Change Title:** Intel® RAID Maintenance Free Backup  
AXXRMFBU2  
PCN 111808-00, Product Design,  
Documentation  
Change Voltage Monitoring Setting, Update  
SuperCap2, Add a Fuse to Cache-offload  
Module and Update User's Guide  
**Date of Publication:** October 30, 2012

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Jan 04, 2013
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## Description of Change to the Customer:

Intel will implement the following changes:

1. The voltage monitoring setting of Intel® RAID Maintenance Free Backup Unit AXXRMFBU2 has been changed to improve voltage reporting accuracy.
2. The SuperCap2 is updated to avoid the Intel® Integrated RAID Module from being damaged if the RMFBU2 cache-offload module cables are misaligned when connected to a charged SuperCap2.
3. Add a fuse to the Intel® RAID Maintenance Free Backup Unit AXXRMFBU2 Cache-offload Module to prevent the MOSFET from being damaged if the RMFBU2 cache-offload module cable is installed backwards.
4. Update the User's Guide for Intel® RAID Maintenance Free Backup Unit AXXRMFBU2 from G49043-002 to G49043-003 to include the latest information.

## Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

## Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
AXXRMFBU2	919876	G46229-201	G50073-201	926341	G46229-301	G50073-301

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
October 30, 2012	00	Originally Published PCN